

产品技术规格书

SPECIFICATION

产品型号 PART NO: LA52H2450/5500-A28
客户料号 CUSTOMER PART NO:
客户确认 CUSTOMER APPROVED BY:
确认日期 APPROVED DATE:

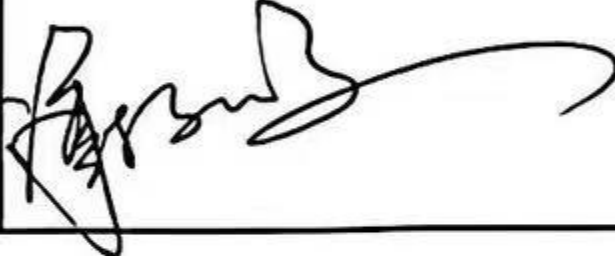
RoHS Compliant Parts

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产品规格书版本更改记录

Version rejigger track record

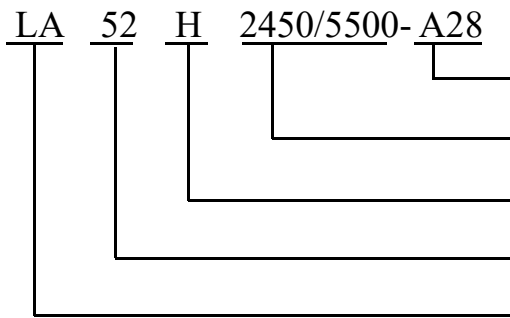
1. 概述 INTRODUCTION

"佳利"微波多层陶瓷天线 LA 系列产品设计用于 WLAN、WiFi、蓝牙、PHS，手机多频天线, FM 等小体积 SMD 片式设计。

"GLEAD" Microwave Multi-Layer Ceramic Antenna LA series are designed to be used in WLAN、WiFi、Bluetooth、PHS、 Multiple-band Mobile phone antenna, FM, etc and compact size SMD chip design.

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2. 型号 Part Number



产品名称, 编号 A28/Product Name: A28

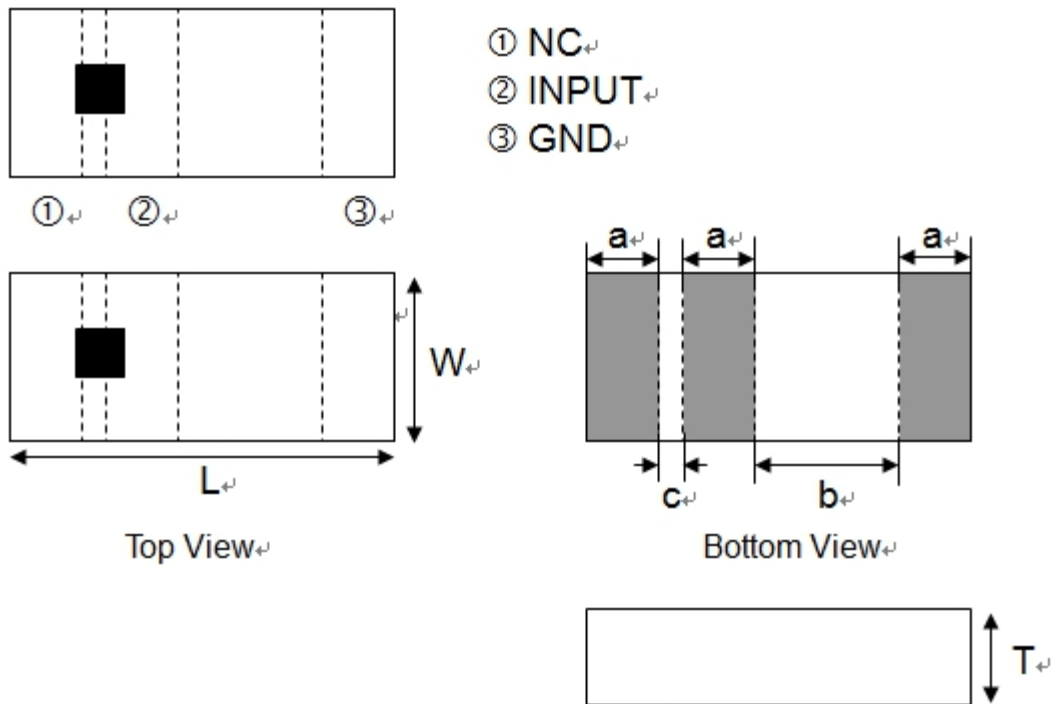
天线频率/ Antenna Frequency: 2450 MHz/5500MHz

产品设计结构 H 型/ Via Design Series

产品尺寸/Size: 5.0×2.0×1.0

多层结构天线/Multi-layer Antenna

3. 外型尺寸及测试板焊盘尺寸 Dimensions (Unit: mm)



Symbol	L	W	T	a	b	c
Dimensions	5.00±0.20	2.0±0.20	1.0±0.2	0.8±0.1	2.0±0.2	0.6±0.2

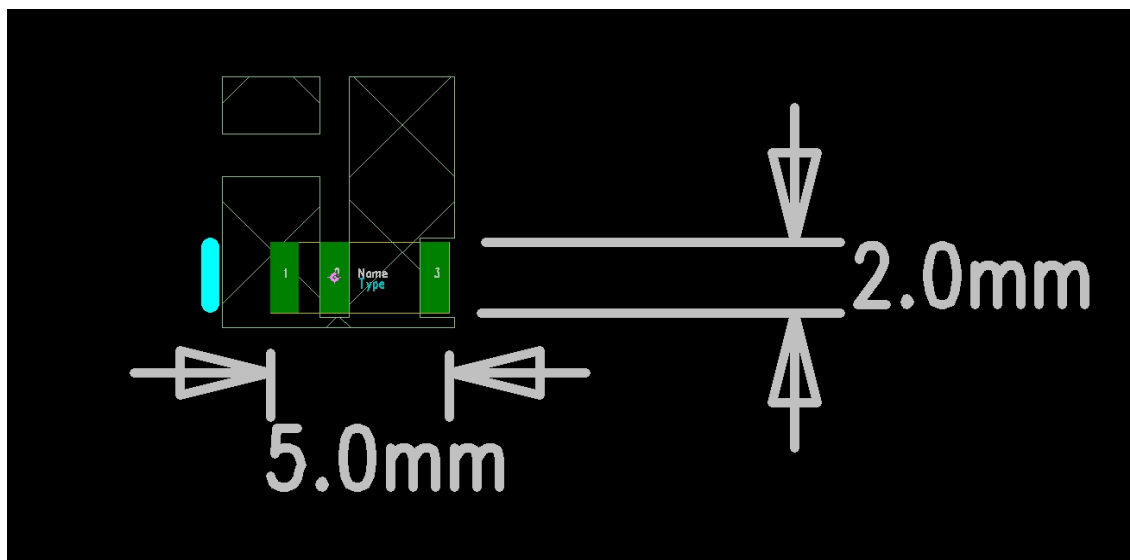
PCB via hole

Clearance area

Unit: mm

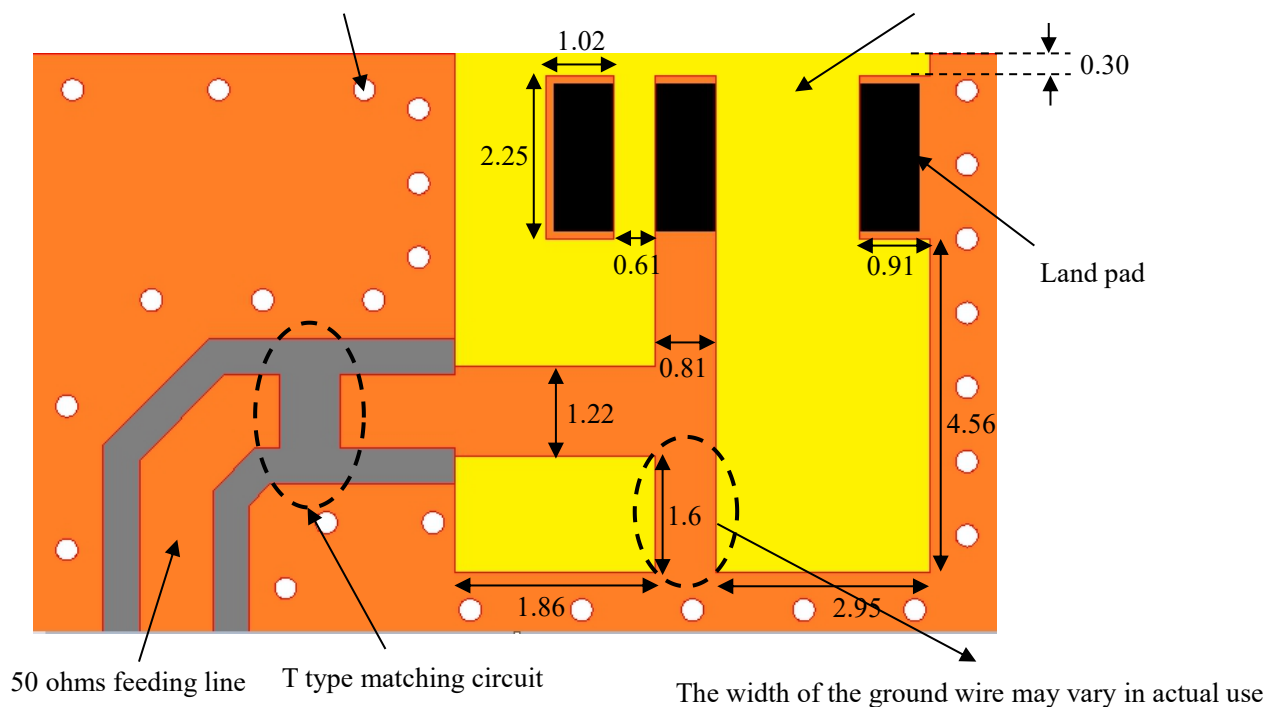
Specification

天线尺寸Antenna Photo & Length (Unit: mm)

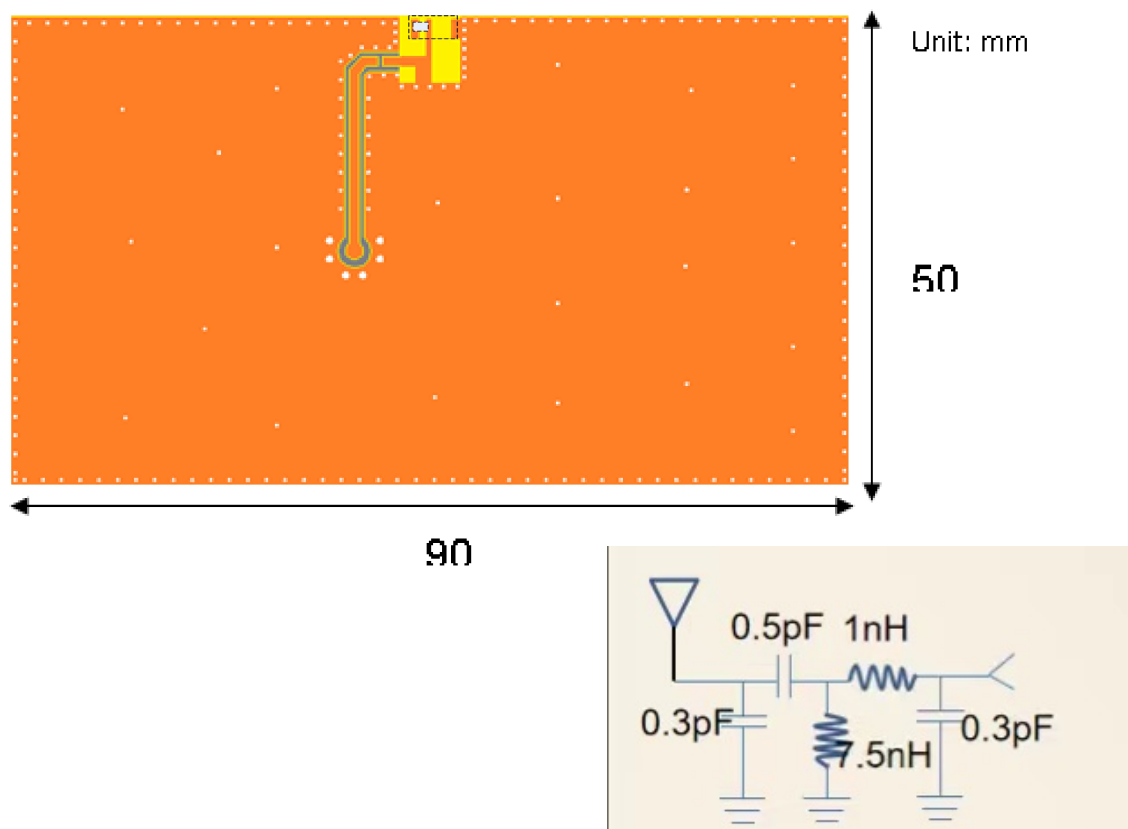


天线类型Antenna Type : Ceramic Antenna

Specification



4. 测试电路和匹配电路 Evaluation Board and Matching Circuits

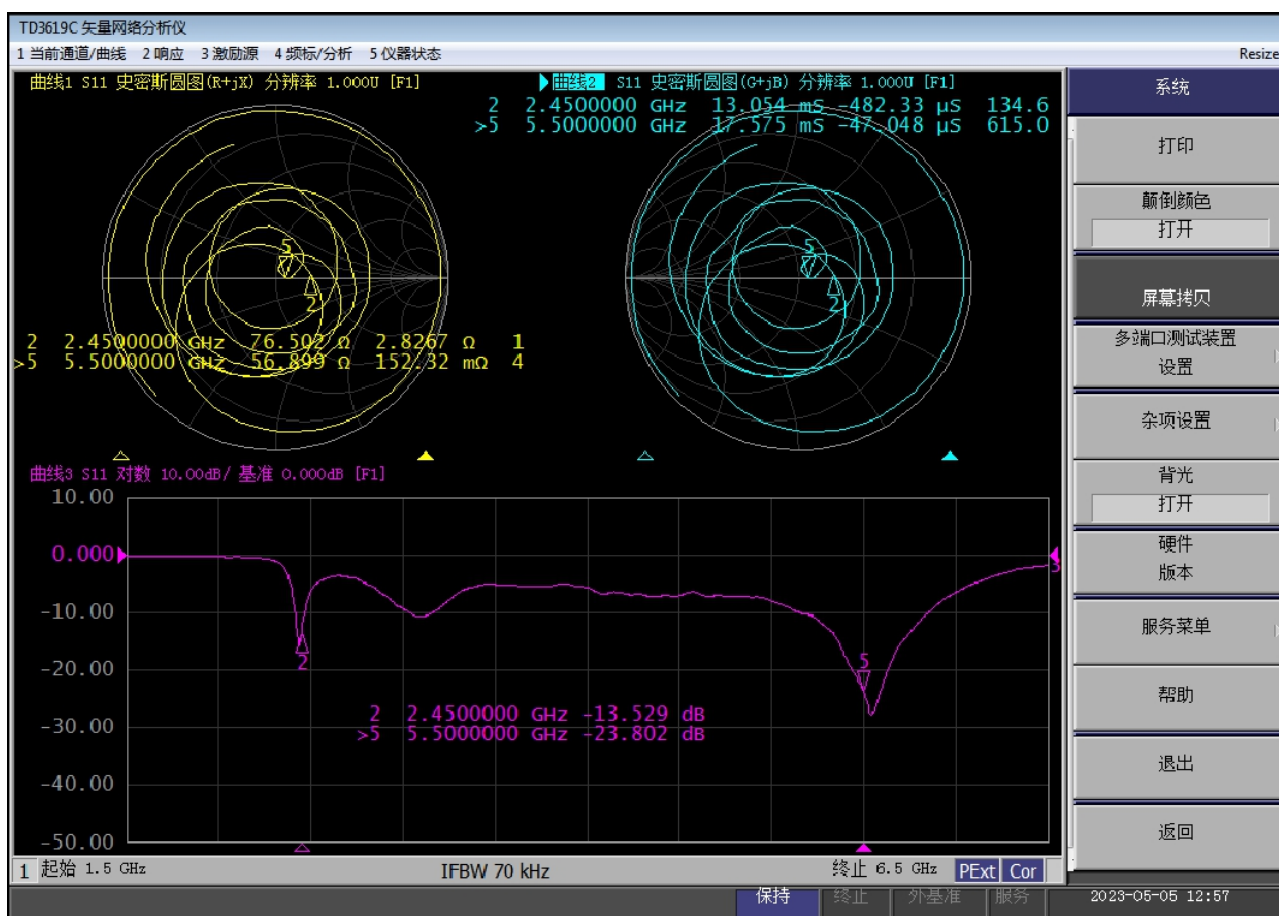


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5. 电气性能 Electrical Characteristics

No.	Item (项目)	Specifications (特性)
5.1	Frequency Range 频率范围	2400 ~ 2500 MHz / 5150 ~ 5850 MHz
	(带匹配电路测试)After Matching	2450 MHz/5500MHz
5.2	Band Width 通带宽度	100MHz (typ.) / 1000 MHz (typ.)
5.3	Peak Gain 峰值增益	1.5dBi / 7.21dBi
5.4	Return Loss 回波损耗	-13 dB (max.) / -27 dB (max.)
5.5	Polarization 极化方式	Linear 线性
5.6	Azimuth Beam width 方位角	Omni-directional 全向
5.7	Impedance 阻抗	50 Ω

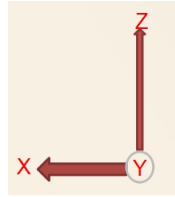
6. 特性曲线 Characteristic curve



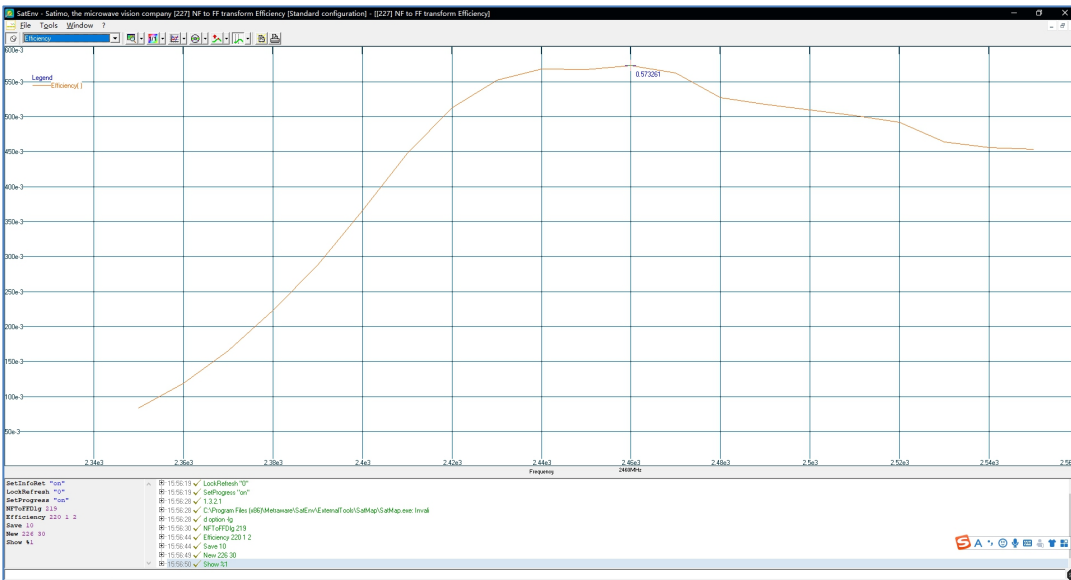
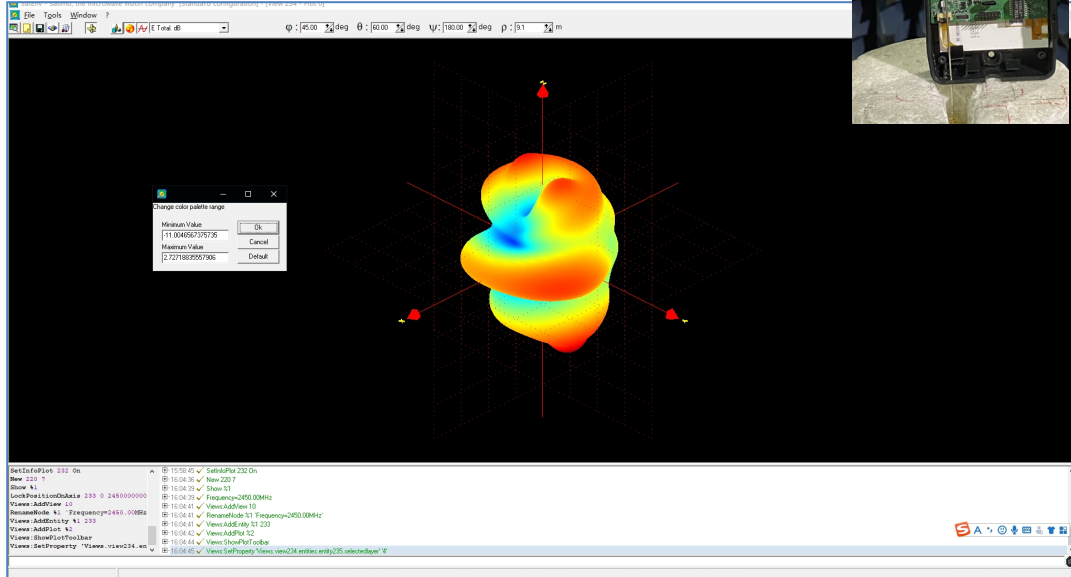
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7. 方向图及效率

Radiation Pattern & Efficiency



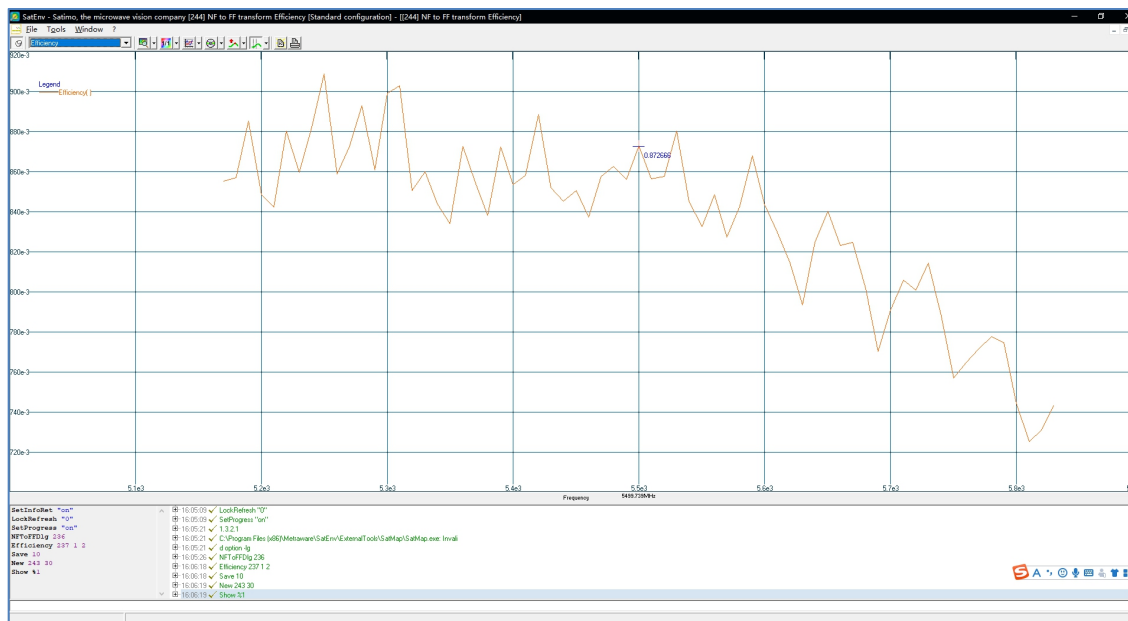
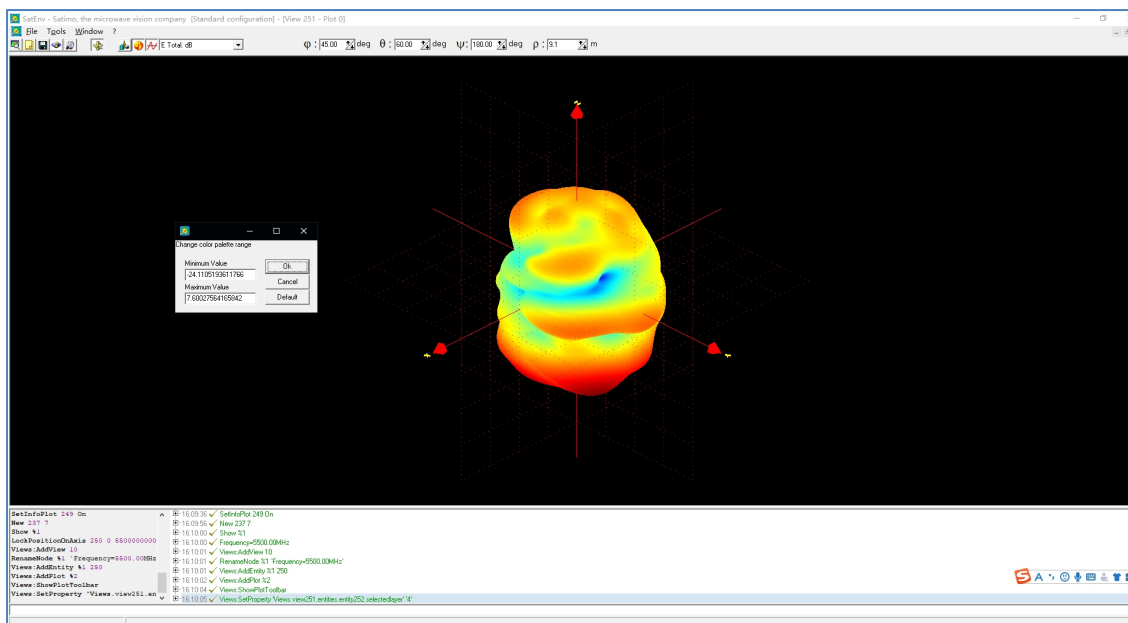
2.4GHz:



Frequency (MHz)	2400	2450	2500
Peak Gain (dBi)	-1.2	1.4	1.5
Avg. Gain (dBi)	-4.3	-2.5	-3.1
Efficiency (%)	35	56	50

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5GHz:



Frequency (MHz)	5180	5500	5820
Peak Gain (dBi)	7.21	6.92	6.00
Avg. Gain (dBi)	-2.0	-2.1	-3.0
Efficiency (%)	85	87	73

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8 可靠性试验后允许误差 Post Dependability Tolerance

经可靠性试验后允许比起始读数偏差见下表

No.	Item (项目)	Post Dependability Tolerance (可靠性试验后允许附加误差)
8.1	Central Frequency 中心频率	± 5 MHz
8.2	Band Width 通带宽度	± 5 MHz
8.3	Gain 增益	± 0.1 dBi
8.4	V.S.W.R (in BW) 驻波比	± 0.1

Post Dependability Tolerance (Refer to the table)

9 可靠性试验 Dependability Test

基准条件: 温度范围 Temperature range	$25 \pm 5^{\circ}\text{C}$
相对湿度范围 Relative Humidity range	55~75%RH
工作温度 Operating Temperature range	$-40^{\circ}\text{C} \sim +85^{\circ}\text{C}$
贮藏温度 Storage Temperature range	$-40^{\circ}\text{C} \sim +85^{\circ}\text{C}$

9.1 耐振动 Vibration Resist

在振动频率为 10~55Hz 振幅为 1.5mm 沿 X.Y.Z 方向各振动 2 小时后测试符合表 8.1~8.4 规定。

The device should satisfy the electrical characteristics specified in paragraph 8.1~8.4 after applied to the vibration of 10 to 55Hz with amplitude of 1.5mm for 2 hours each in X, Y and Z directions.

9.2 耐跌落冲击 Drop Shock

在 100cm 高度处按 X, Y, Z 三个面分别自由跌落在木制地板上共 3 次后测试符合表 8.1~8.4 规定。

The device should satisfy the electrical characteristics specified in paragraph 8.1~8.4 after dropping onto the hard wooden board from the height of 100cm for 3 times each facet of the 3 dimensions of the device.

9.3 耐焊接热 Solder Heat Proof

能承受经 120~150°C 的温度预热 120 秒后, 在 255°C+10°C 的焊锡浸 5±0.5 秒, 或 300°C-10°C 的电烙铁焊接 3±0.5 秒, 焊接面无损伤。

The device should be satisfied after preheating at 120°C~150°C for 120 seconds and dipping in soldering Sn at 255°C+10°C for 5±0.5 seconds, or electric iron 300°C-10°C for 3±0.5 seconds, without damage.

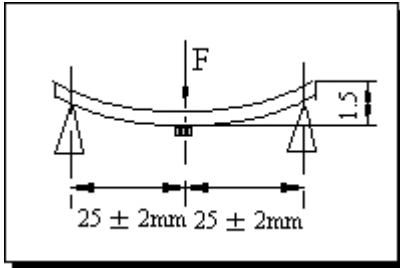
9.4 推力试验 Adhesive Strength of Termination

在产品电极端子上或表面上可承受 5N (≤ 0603); 10N (>0603) 水平推力 10±1 秒而无明显外观损坏与电极移位。

The device have no remarkable damage or removal of the termination after horizontal force of 5N (≤ 0603); 10N (>0603) with 10±1 seconds.

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9.5 耐弯曲试验 Bending Resist Test



将产品按图焊在 $1.6 \pm 0.2\text{mm}$ 的 PCB 板中间，由箭头方向施力： 1mm/S ，弯曲距离： 1.5mm ，保持 $5 \pm 1\text{S}$ ，产品金属层无脱落。

Weld the product to the center part of the PCB with the thickness $1.6 \pm 0.2\text{mm}$ as the illustration shows, and keep exerting force arrow-ward on it at speed of 1mm/S , and hold for $5 \pm 1\text{S}$ at the position of 1.5mm bending distance, so far, any peeling off of the

product metal coating should not be detected.

9.6 耐湿热特性 Moisture Proof

在温度为 $60 \pm 2^\circ\text{C}$ ，相对湿度 $90\sim 95\%$ 的恒温湿箱中放置 96 小时，在常温中恢复 1~2 小时后测试，符合表 8.1~8.4 规定。

The device should satisfy the electrical characteristics specified in paragraph 8.1~8.4 after exposed to the temperature $60 \pm 2^\circ\text{C}$ and the relative humidity $90\sim 95\% \text{ RH}$ for 96 hours and 1~2 hours recovery time under normal condition.

9.7 高温特性 High Temperature Endurance

在温度为 $85 \pm 5^\circ\text{C}$ 的恒温箱中放置 96 ± 2 小时，在常温中恢复 1~2 小时后测试。符合表 8.1~8.4 规定。

The device should satisfy the electrical characteristics specified in paragraph 8.1~8.4 after exposed to temperature $85 \pm 5^\circ\text{C}$ for 96 ± 2 hours and 1~2 hours recovery time under normal temperature.

9.8 低温特性 Low Temperature Endurance

在温度为 $-40^\circ\text{C} \pm 5^\circ\text{C}$ 低温箱中放置 96 ± 2 小时后恢复 1~2 小时测试符合表 8.1~8.4 规定。

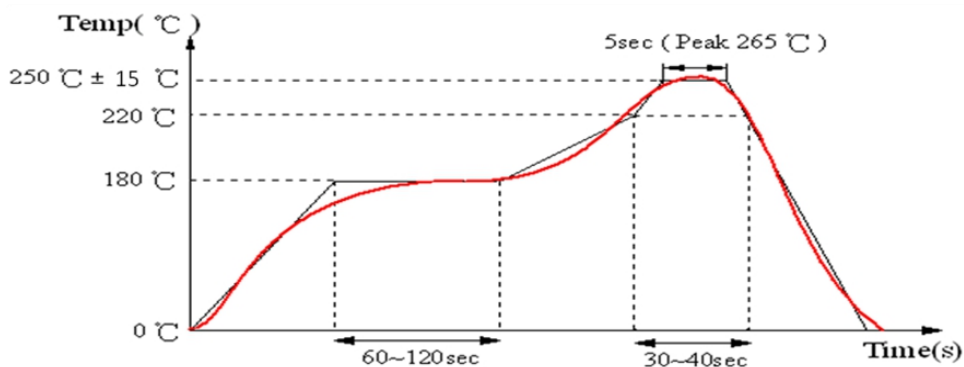
The device should also satisfy the electrical characteristics specified in paragraph 8.1~8.4 after exposed to the temperature $-40^\circ\text{C} \pm 5^\circ\text{C}$ for 96 ± 2 hours and to 2 hours recovery time under normal temperature.

9.9 温度循环 Temperature Cycle Test

在 -40°C 温度中保持 30 分钟，再在 $+85^\circ\text{C}$ 温度中保持 30 分钟，共循环 5 次后在常温中恢复 1~2 小时后测试符合表 8.1~8.4 规定。

The device should also satisfy the electrical characteristics specified in paragraph 8.1~8.4 after exposed to the low temperature -40°C and high temperature $+85^\circ\text{C}$ for 30 ± 2 min each by 5 cycles and 1 to 2 hours recovery time under normal temperature.

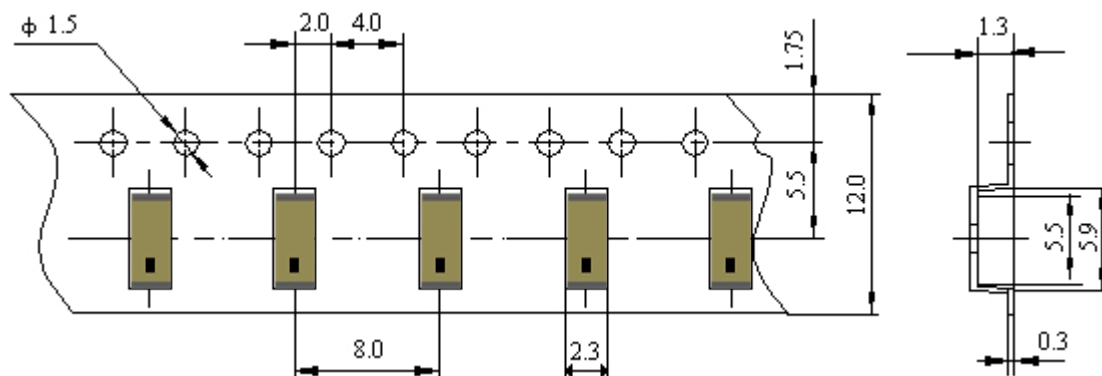
10 回流焊温度 Reflow Soldering Standard Condition



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11 包装尺寸 (5020) Packaging and Dimensions

11.1 Plastic Tape

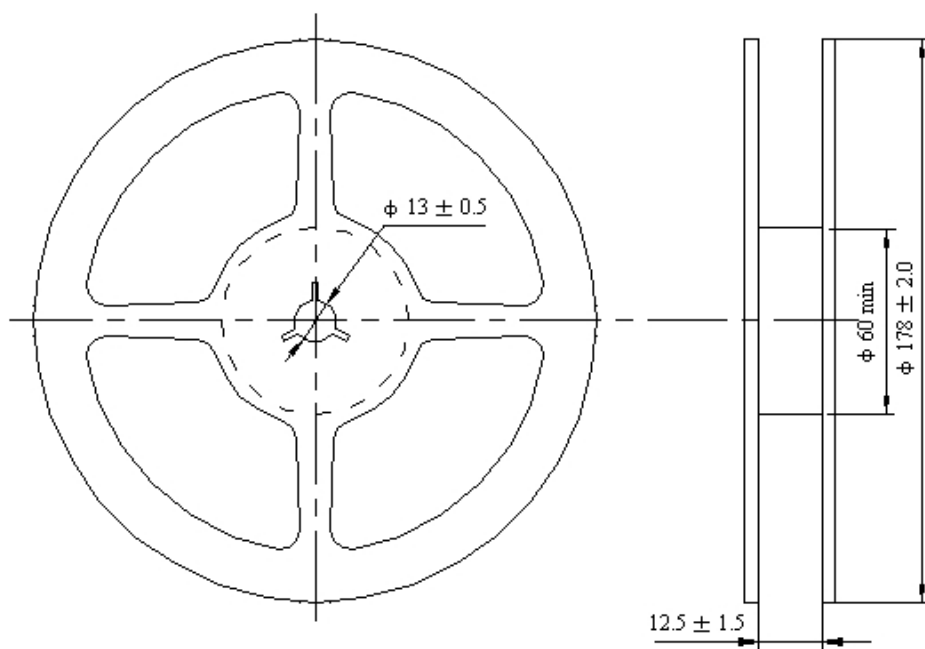


包装说明: Remarks for Package

载带尾部空穴长度 150~200mm, 载带头部空穴长度 250~300mm, 头部的盖带加长 250mm。

Reserve a length of 150~200mm for the trailer of the carrier and 250~300 mm for the leader of the carrier and further 250mm of cover tape at the leading part of the carrier.

11.2 Reel (3000 pcs/Reel)



11.3 储存条件 Storage Period

产品收到后一年内使用完毕。

Product should be used within twelve months of receipt.

湿敏等级 1 / 储存温度与湿度:

MSL 1 / Storage Temperature Range : <math><30</math> degree C, Humidity : <math><85\%RH</math>